

## **ABSTRACT OF THE DISCLOSURE**

A method of forming a laminated circuit is described as follows: designing the laminated circuit in computer, recording the circuit layout of the laminated circuit into a data file subject to a

5 predetermined format, inputting the data file into the main control unit of a laminated circuit forming apparatus for conversion into sequential control signals to drive insulative material sprayer, conductive material sprayer, and impedance material sprayer to eject respective fluid insulative materials onto a platform at

10 different times and locations subject to the sequential control signals, forming the desired laminated circuit having an insulative body, electric circuits and passive components in it.